NOT RECOMMENDED FOR NEW DESIGN **NO ALTERNATE PRODUCT**



DMS3014SSS

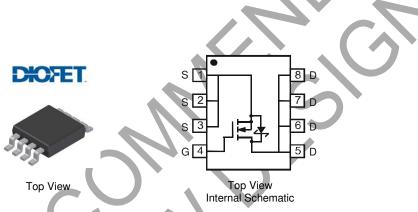
N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE

Features

- DIOFET Utilizes a Unique Patented Process to Monolithically Integrate a MOSFET and a Schottky in a Single Die to Deliver:
 - Low R_{DS(ON)}—Minimizes Conduction Losses
 - Low V_{SD}—Reduces Losses Due to Body Diode Conduction
 - Low Q_{rr}—Lower Q_{rr} of the Integrated Schottky Reduces Body Diode Switching Losses
 - Low Gate Capacitance (Qg/Qgs) Ratio—Reduces Risk of Shoot-Through or Cross Conduction Currents at High Frequencies
 - Avalanche Rugged-IAR and EAR Rated
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Marking Information: See Page 5
- Weight: 0.072 grams (Approximate)



Ordering Information (Note 4)

Part Number	Case	Packaging
DMS3014SSS-13	SO-8	2500/Tape & Reel

Note:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) complia 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and ead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain < 900ppm bromine, < 900ppm chlorine (< 1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/.



Maximum Ratings @TA = 25°C unless otherwise specified

Characteri	Symbol	Value	Unit		
Drain-Source Voltage			V_{DSS}	30	V
Gate-Source Voltage			V _{GSS}	±12	V
Continuous Drain Current (Note 5) V _{GS} = 4.5V	Steady State	TA = 25°C TA = 85°C	I _D	10.4 6.6	А
Pulsed Drain Current (Note 6)	I _{DM}	63	Α		
Avalanche Current (Notes 6 & 7)	I _{AR}	30	Α		
Repetitive Avalanche Energy (Notes 6 & 7) L = 0.1mH			E _{AR}	45	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P_{D}	1.55	W
Thermal Resistance, Junction to Ambient @T _A = 25°C (Note 5)	Reja	81.3	°C/W
Operating and Storage Temperature Range	TJ, T _{STG}	-55 to +150	°C

Notes:

- 5. Device mounted on 1in × 1in FR-4 PCB with 2oz. Copper. The value in any given application depends on the user's specific board design.
 6. Repetitive rating, pulse width limited by junction temperature.
 7. I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = 25°C.

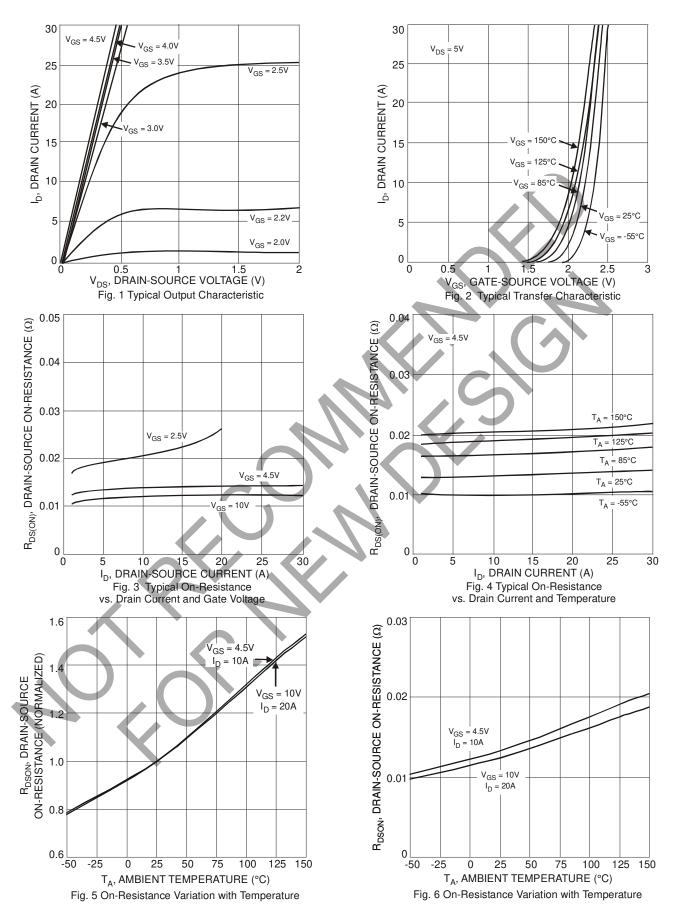
Electrical Characteristics @ T_A = 25°C unless otherwise stated

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}		(–)	100	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_		±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage	V _{GS(th)}	1.0	-	2.2	٧	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	D A		9	13	mΩ	$V_{GS} = 10V, I_D = 10.4A$	
Static Dialif-Source Off-Nesistatice	R _{DS} (ON)		10	14	11122	$V_{GS} = 4.5V, I_D = 10.4A$	
Forward Transfer Admittance	Y _{fs}	þ	23	l	S	$V_{DS} = 5V, I_{D} = 10.4A$	
Diode Forward Voltage	V_{SD}) 	0.37	0.5	٧	$V_{GS} = 0V, I_{S} = 1A$	
Maximum Body-Diode + Schottky Continuous Current	1 _S		_	5	Α	_	
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance	Ciss	I	2296	I	pF	V 45V V 0V	
Output Capacitance	Coss	l	164	l	рF	V _{DS} = 15V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	C _{rss}		120		pF	1 = 1.01/11/12	
Gate Resistance	R_g	0.26	1.3	2.34	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge V _{GS} = 4.5V	Q_g	_	19.3	_	nC	·	
Total Gate Charge V _{GS} = 10V	Q_g	_	45.7	_	nC	V 15V V 10V L 10 1A	
Gate-Source Charge	Qgs	_	5.0	_	nC	$V_{DS} = 15V, V_{GS} = 10V, I_{D} = 10.4A$	
Gate-Drain Charge	Q_{gd}	_	2.9	_	nC		
Turn-On Delay Time	t _{D(on)}	1	5.5		ns		
Turn-On Rise Time	t _r	1	24.4		ns	$V_{GS} = 10V, V_{DS} = 15V,$	
Turn-Off Delay Time	t _{D(off)}	1	33.1	1	ns	$R_G = 3\Omega$, $R_L = 1.2\Omega$	
Turn-Off Fall Time	t _f	_	6.6	_	ns]	

Notes:

- 8. Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.







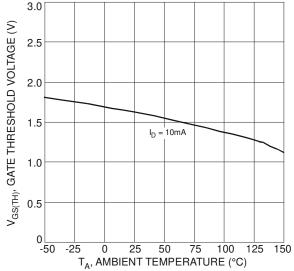
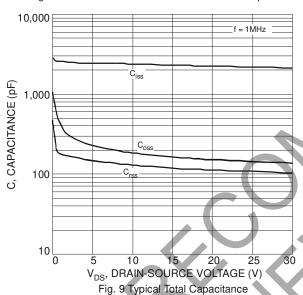


Fig. 7 Gate Threshold Variation vs. Ambient Temperature



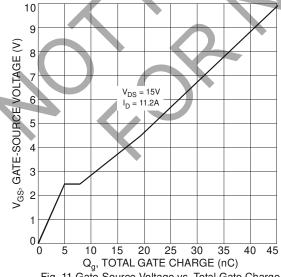
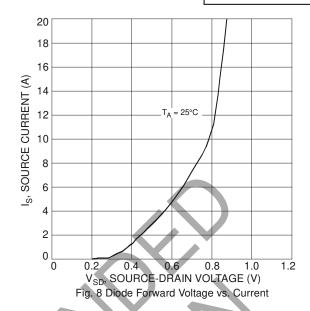
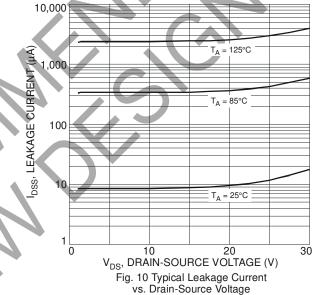
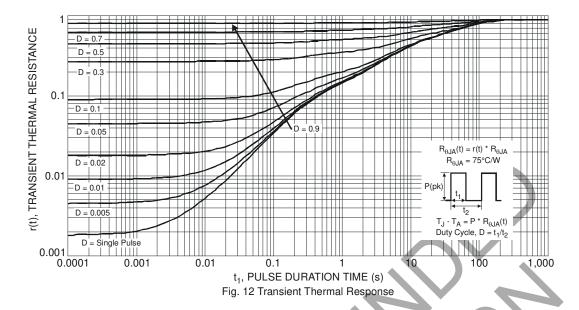


Fig. 11 Gate-Source Voltage vs. Total Gate Charge



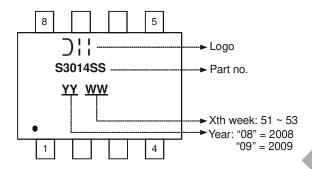








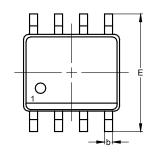
Marking Information

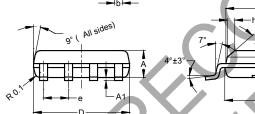


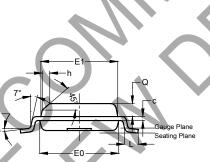
SO-8

Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.





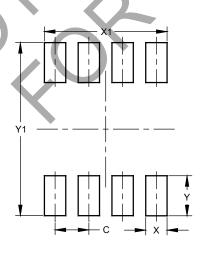


SO-8

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SO-8					
Dim	Min	Max	Тур		
Α	1.40	1.50	1.45		
A1	0.10	0.20	0.15		
b	0.30	0.50	0.40		
С	0.15	0.25	0.20		
D	4.85	4.95	4.90		
Е	5.90	6.10	6.00		
E1	3.80	3.90	3.85		
E0	3.85	3.95	3.90		
е	_	_	1.27		
h	_	_	0.35		
٦	0.62	0.82	0.72		
Ø	0.60	0.70	0.65		
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)		
С	1.27		
Х	0.802		
X1	4.612		
Υ	1.505		
Y1	6.50		



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